Load Switches

Quick Reference Guide





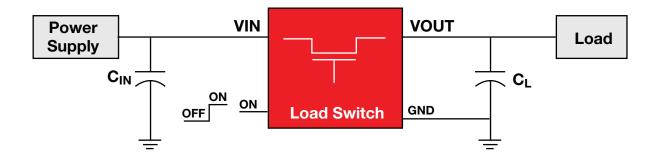
Load switches are a simple, inexpensive way to save and sequence power throughout any space constrained system. The most critical load switch parameters are input voltage range, maximum continuous current, ON-Resistance*, and package size. On this quick reference card you will find TI's most popular load switches which can fit into any kind of application.

Browse the complete load switch portfolio: www.ti.com/loadswitch

GPN	V _{IN} Min	V _{IN} Max	I _{MAX} (A)	R _{ON*} (mΩ)	Special Features	Size	Package
TPS22965	0.8	5.7	6	16	Adjustable Rise Time, V _{BIAS} Supply, Optional Quick Output Discharge	2 x 2mm	WSON-8
TPS22954	0.7	5.7	5	14	Power Good, Adj. Rise Time, V _{BIAS} Supply, Optional QOD / Reverse Current Protection	2 x 2mm	WSON-10
TPS22915	1.05	5.5	2	38	Quick Output Discharge	0.8 x 0.8mm	DSBGA-4
TPS22920	0.75	3.6	4	5.3	Quick Output Discharge Optional Active Low	1.9 x 0.9mm	DSBGA-8
TPS22968	0.8	5.5	4	25	Dual Channel (4A per ch), Adj. Rise Time, Quick Output Discharge, V _{BIAS} Supply	2 x 3mm	WSON-14
TPS22963C	1.0	5.5	3	13.8	Reverse Current Protection	1.4 x 0.9mm	DSBGA-6
TPS22960	1.62	5.5	0.5	435	Dual Channel (0.5A per ch), Quick Output Discharge	1.5 x 1.5mm 3 x 3mm	uQFN or SOT-23
TPS22929D	1.4	5.5	1.8	115	Quick Output Discharge, Reverse Current Protection	3 x 3mm	S0T-23
TPS22990	0.6	5.5	10	4.4	Power Good, Adjustable Rise Time, Quick Output Discharge	2 x 3mm	WSON-10

ON-Resistance (R_{ON}) is the resistance across the load switch from V_{IN} to V_{OUT} . R_{ON} is not the same as $R_{DS(ON)}$, pass FET resistance, which ignores additional resistance from the bond wires & packaging.

Preview devices are listed in bold teal.



Design Resources and Support

More Device Information

ti.com/loadswitch

Application Notes

SLVA652: What is a Load Switch?

• SLVUA74: Load Switch Thermal Considerations

SLVA670A: Managing Inrush Current

TI Designs

- TIDA-00194: Power Regulation & Distribution for Intel SkyLake(TM) Processor Platform Reference Design
- TIDA-00513: Parallel Load Switches for Higher Output Current & Reduced ON-Resistance Reference Design
- TIDA-00399: SSD Power Delivery Reference Design

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• Load Switches and Power Path Protection: http://e2e.ti.com/support/power_management/switches/

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Note: Toll-free numbers may not support

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